TOSHIBA Diode Silicon Epitaxial Planar Type

1SS361F

Ultra High Speed Switching Applications

Unit in mm

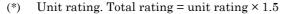
Small package : 1608 Flat lead Excellent in forward current and forward voltage characteristics $V_{F(3)} = 0.9V \text{ (typ.)}$ Fast reverse recovery time: $t_{rr} = 1.6ns$ (typ.)

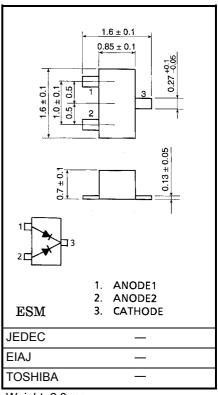
Maximum Ratings (Ta = 25°C)

Small total capacitance

Characteristic	Symbol	Rating	Unit	
Maximum (peak) reverse voltage	V_{RM}	85	V	
Reverse voltage	V _R	80	V	
Maximum (peak) forward current	I _{FM}	300 (*)	mA	
Average forward current	Io	100 (*)	mA	
Surge current (10ms)	I _{FSM}	2 (*)	Α	
Power dissipation	Р	100	mW	
Junction temperature	Tj	125	°C	
Storage temperature range	T _{stg}	-55~125	°C	

 $: C_T = 0.9 pF (typ.)$





Weight: 2.3 mg

Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Forward voltage	V _{F (1)}	_	I _F = 1mA	_	0.60	_	
	V _{F (2)}	_	I _F = 10mA	_	0.72	_	V
	V _{F (3)}	_	I _F = 100mA	_	0.90	1.20	
Reverse current	I _{R (1)}	_	V _R = 30V	_	_	0.1	
	I _{R (2)}	_	V _R = 80V	_	_	0.5	μА
Total capacitance	C _T	_	V _R = 0, f = 1MH _z	_	0.9	3.0	pF
Reverse recovery time	t _{rr}	_	I _F = 10mA (Fig.1)	_	1.6	4.0	ns

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Fig.1 Reverse Recovery Time (trr) Test Circuit

Marking

